

QSFP28-100GB-ER4-N-OPC

Alcatel-Lucent Nokia® Compatible TAA 100GBase-ER4 QSFP28 Transceiver (SMF, 1295nm to 1309nm, 40km, LC, DOM)

Features

- SFF-8665 Compliance
- Duplex LC Connector
- Single-mode Fiber
- Commercial Temperature 0 to 70 Celsius
- Hot Pluggable
- Metal with Lower EMI
- Excellent ESD Protection
- RoHS Compliant and Lead Free



Applications:

- 100GBase Ethernet

Product Description

This Alcatel-Lucent Nokia® compatible QSFP28 transceiver provides 100GBase-ER4 throughput up to 40km over single-mode fiber (SMF) using a wavelength of 1295nm to 1309nm via an LC connector. It is built to MSA standards and is uniquely serialized and data-traffic and application tested to ensure that they will integrate into your network seamlessly. Digital optical monitoring (DOM) support is also present to allow access to real-time operating parameters. This transceiver is Trade Agreements Act (TAA) compliant. We stand behind the quality of our products and proudly offer a limited lifetime warranty.

Absolute Maximum Ratings

Parameter	Symbol	Min.	Typ.	Max.	Unit
Storage Temperature	Tstg	-40		85	°C
Operating Case Temperature	Tc	0	25	70	°C
Power Supply Voltage	Vcc	-0.5		4.0	V
Relative Humidity	RH	5		95	%
Data Rate Per Channel			25.78125		Gbps

Electrical Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Notes
Supply Voltage	Vcc	3.135	3.3	3.465	V	
Module Supply Current	Icc			1500	mA	
Power Dissipation	P _{DISS}			5000	mW	
Transmitter						
Single-Ended Input Voltage Tolerance		-0.3		4.0	V	
Input Differential Impedance	ZIN		100		Ω	
Differential Data Input Swing	VIN,pp	190		700	mVp-p	
AC Common-Mode Input Voltage Tolerance		15			mV	
Differential Input Voltage Swing Threshold			50		mVp-p	
Receiver						
Single-Ended Output Voltage		-0.3		4.0	V	
Output Differential Impedance	ZOUT	90	100	110	Ω	
Differential Data Output Swing	VOOUT,pp	300		850	mVp-p	
AC Common-Mode Output Voltage				7.5	mV	

Optical Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Notes
Transmitter						
Launch Optical Power Per Lane	Po	-2.9		+2.9	dBm	1
Total Launch Optical Power	Po			+8.9	dBm	1
Center Wavelength Range	L1	1294.53	1295.56	1296.59	nm	
	L2	1299.02	1300.05	1301.09	nm	
	L3	1303.54	1304.58	1305.63	nm	
	L4	1308.09	1309.14	1310.19	nm	
Extinction Ratio	ER	8.0			dB	2
Spectral Width (-20dB)	$\Delta\lambda$			1	nm	
Side-Mode Suppression Ratio	SMSR	30			dB	
Optical Return Loss Tolerance	ORLT			20	dB	
POUT @Tx_Disable Asserted	Poff			-30	dBm	1
Eye Mask: (X1, X2, X3, Y1, Y2, Y3)		(0.25, 0.4, 0.45, 0.25, 0.28, 0.4)				
Receiver						
Center Wavelength	L1	1294.53	1295.56	1296.59	nm	
	L2	1299.02	1300.05	1301.09	nm	
	L3	1303.54	1304.58	1305.63	nm	
	L4	1308.09	1309.14	1310.19	nm	
Sensitivity Per Channel (OMA)	S			-21.4	dBm	3
Overload (Per Channel)	POL	+2.0			dBm	3
Damage Threshold (Per Channel)	Pdamage	+5.5			dBm	
Receiver Reflectance	Rf			-26	dB	
LOS De-Assert	LOSD			-28.0	dBm	
LOS Assert	LOSA	-35.0			dBm	
LOS Hysteresis		0.5		5.0	dB	

Notes:

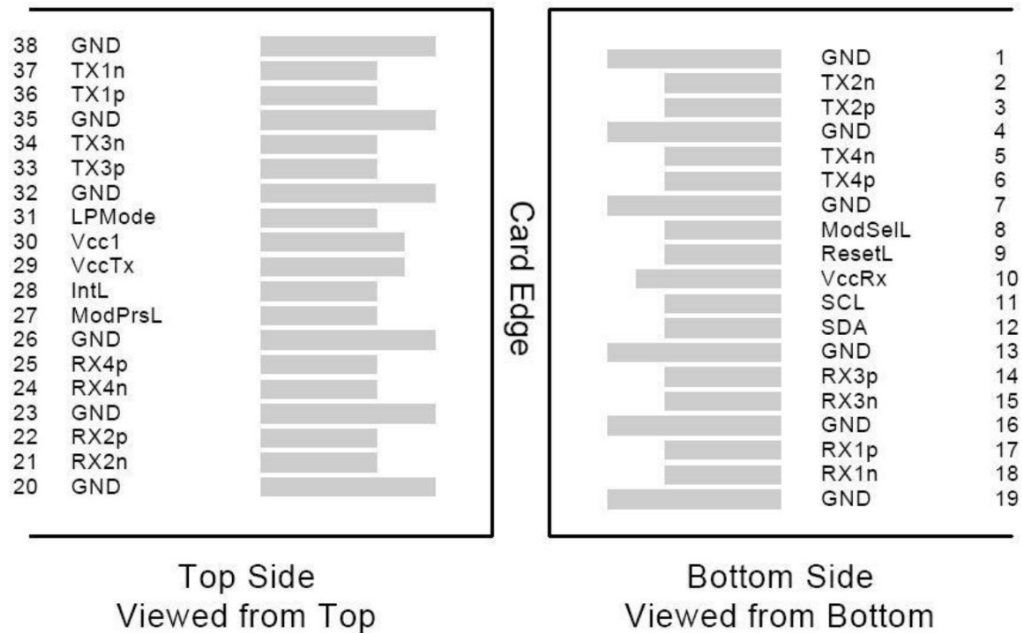
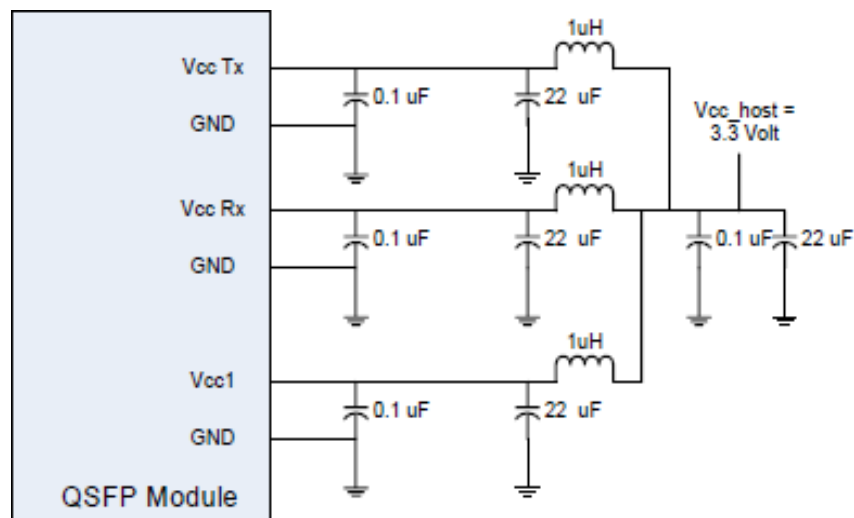
1. The optical power is launched into SMF.
2. Measured with a PRBS 2³¹-1 test pattern @25.78125Gbps.
3. Measured with PRBS 2³¹-1 test pattern, @25.78125Gbps, and BER 1.0E⁻¹².

Pin Descriptions

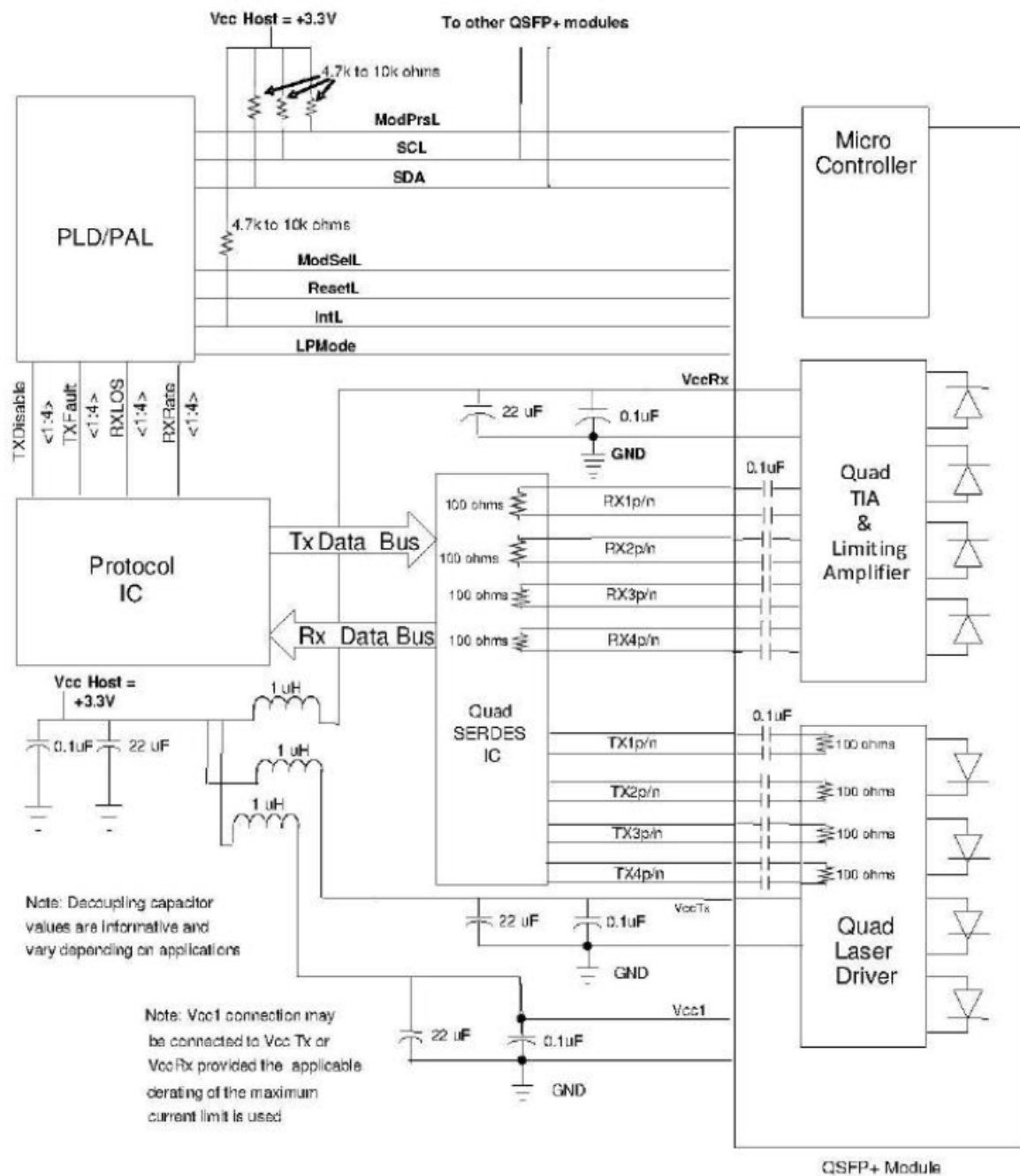
Pin	Logic	Symbol	Name/Description	Notes
1		GND	Module Ground.	1
2	CML-I	Tx2-	Transmitter Inverted Data Input.	
3	CML-I	Tx2+	Transmitter Non-Inverted Data Input.	
4		GND	Module Ground.	1
5	CML-I	Tx4-	Transmitter Inverted Data Input.	
6	CML-I	Tx4+	Transmitter Non-Inverted Data Input.	
7		GND	Module Ground.	1
8	LVTTL-I	MODSEIL	Module Select.	2
9	LVTTL-I	ResetL	Module Reset.	2
10		VccRx	+3.3V Receiver Power Supply.	
11	LVC MOS-I	SCL	2-Wire Serial Interface Clock.	2
12	LVC MOS-I/O	SDA	2-Wire Serial Interface Data.	2
13		GND	Module Ground.	1
14	CML-O	Rx3+	Receiver Non-Inverted Data Output.	
15	CML-O	Rx3-	Receiver Inverted Data Output.	
16		GND	Module Ground.	1
17	CML-O	Rx1+	Receiver Non-Inverted Data Output.	
18	CML-O	Rx1-	Receiver Inverted Data Output.	
19		GND	Module Ground.	1
20		GND	Module Ground.	1
21	CML-O	Rx2-	Receiver Inverted Data Output.	
22	CML-O	Rx2+	Receiver Non-Inverted Data Output.	
23		GND	Module Ground.	1
24	CML-O	Rx4-	Receiver Inverted Data Output.	
25	CML-O	Rx4+	Receiver Non-Inverted Data Output.	
26		GND	Module Ground.	1
27	LVTTL-O	ModPrsL	Module Present. Internally pulled down to the GND.	
28	LVTTL-O	IntL	Interrupt output should be pulled up on the host board.	2
29		VccTx	+3.3V Transmitter Power Supply.	
30		Vcc1	+3.3V Power Supply.	
31	LVTTL-I	LPMODE	Low-Power Mode.	2
32		GND	Module Ground.	1
33	CML-I	Tx3+	Transmitter Non-Inverted Data Input.	
34	CML-I	Tx3-	Transmitter Inverted Data Input.	
35		GND	Module Ground.	1
36	CML-I	Tx1+	Transmitter Non-Inverted Data Input.	
37	CML-I	Tx1-	Transmitter Inverted Data Input.	
38		GND	Module Ground.	1

Notes:

1. Module circuit ground is isolated from the module chassis ground within the module.
2. Open collector. Should be pulled up with 4.7kΩ to 10kΩ on the host board to a voltage between 3.15V and 3.6V.

Electrical Pin-Out Details**Recommended Host Board Power Supply Filter Network**

Recommended Application Interface Block Diagram



Mechanical Specifications

